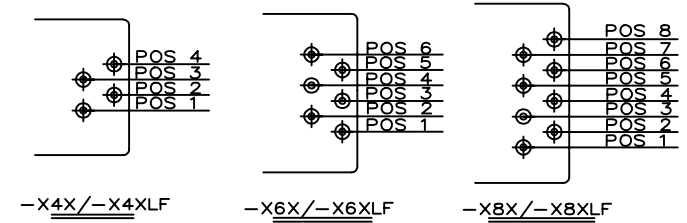
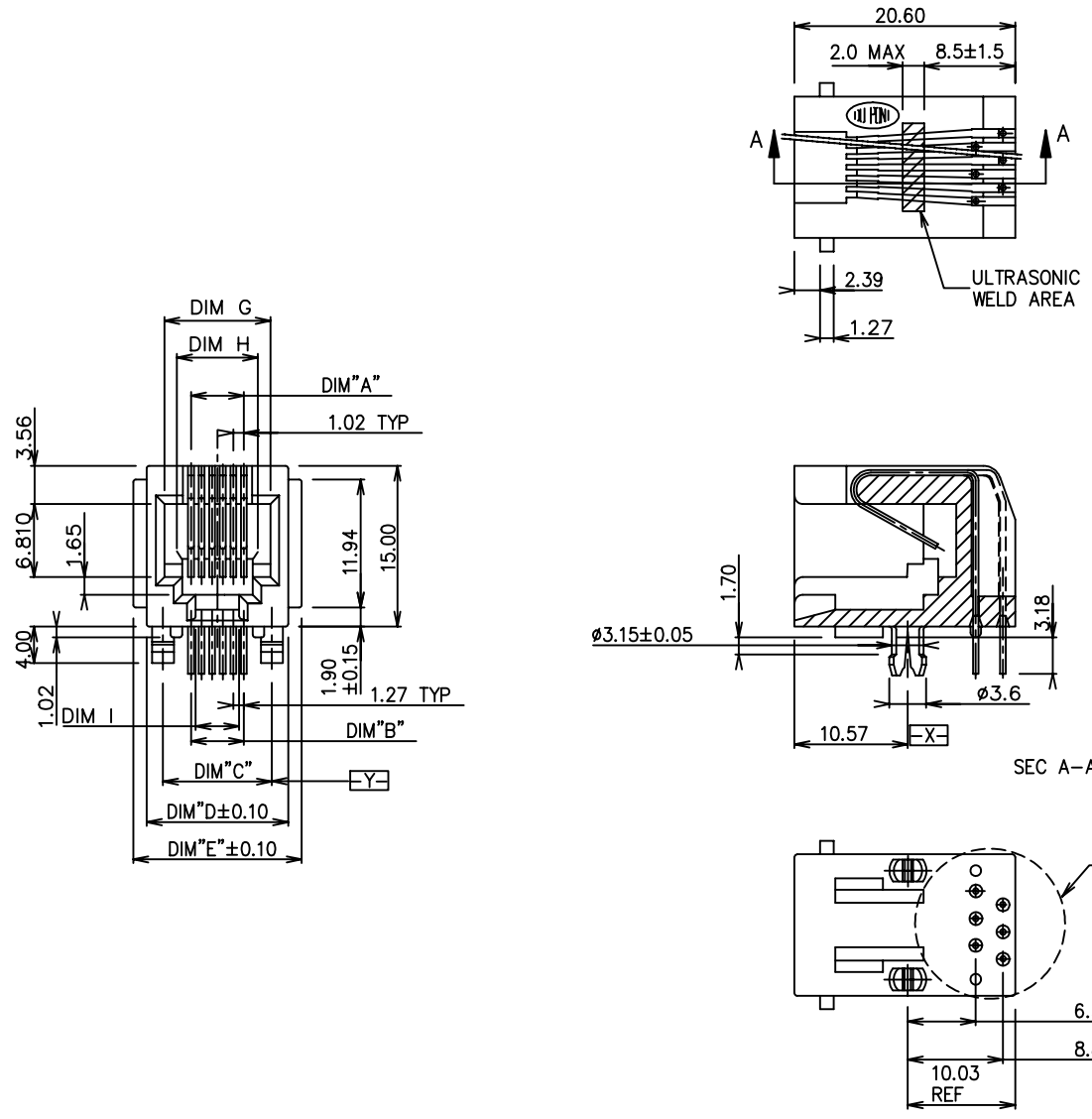


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- NOTES:
1. RECOMMENDED P.C.B. THICKNESS 1.60 MM.
 2. HOUSING MATERIAL: ZYTEL FR50, COLOR: SEE TABLE.
 3. CONTACTS: PHOS BRONZE ALLOY UNS-C51000, 0.460 DIA. ROUND WIRE. PLATING SEE TABLE.
 4. PACKAGE PER BUS-14-164. (TUBE PACKAGING) WHEN PART NUMBER IS 88400-XXXT/-XXXTLF, APPLY PACKAGING SPEC. GES-14-351 (TRAY PACKAGING).
 5. THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
 6. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD.
 7. IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION.

mat'l code					tolerance unless otherwise specified		CUSTOMER COPY		 www.fciconnect.com		
rev.	ecn no.	dr	date		linear	.0 ± 0.25		projection	title SNAP-IN MODULAR JACK ASS'Y		
K	T90139	M	04/06/99			.00 ± 0.13					
L	N05-0019	YS	01/27/05			.000± 0.05					
					angles	± 2°					
					dr	KCHOU	04/26/92		unit	product family	
					engr	TONY CHIEN	04/26/92		mm/inch	code	
					chr	TONY CHIEN	04/26/92		scale	TWN	
					appd	JENN TSAO	04/26/92	2/1	A3	dwg no.	sheet
										88400	1 OF 2
sheet	revision	L	L								
index	sheet	1	2								

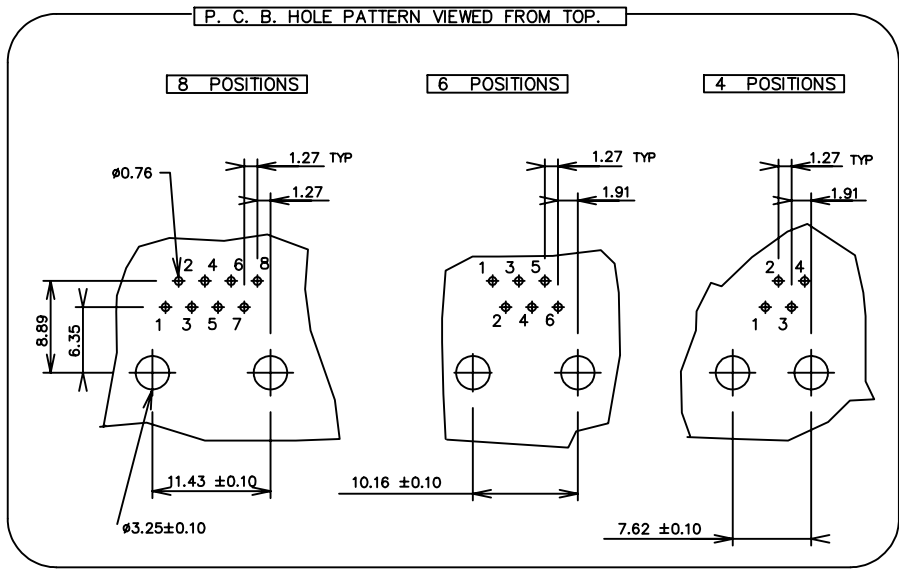
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DIM.	NO OF POS	DIM A	DIM B	DIM C	DIM D	DIM E	DIM G	DIM H	DIM I	LOADED POS	REMARK
88400-X44/-X44LF	4	3.05	3.81	7.62	11.20	13.72	7.87	5.50	3.05	ALL POS	
88400-X42/-X42LF										2,3	
88400-X66/-X66LF	6	5.08	6.35	10.16	13.20	15.72	9.906	6.60	4.06	ALL POS	
88400-X64/-X64LF										2,3,4,5	
88400-X62/-X62LF										3,4	
88400-X88/-X88LF	8	7.11	8.89	11.43	15.24	17.76				ALL POS	NOT AVAILABLE
88400-X86/-X86LF										2,3,4,5,6,7	
88400-X84/-X84LF										3,4,5,6	

PLATING & HSG COLOR CODE	PLATING	HSG COLOR
0	30 v " G.X.T.	BLACK
1	15 v " GOLD.	
2	20 v " GFPD.	
3	30 v " GOLD.	
4	15 v " G.X.T.	
5	50 v " GOLD.	
6	6 v " GOLD.	
7	2 v " GOLD.	



mat'l code				tolerance unless otherwise specified		CUSTOMER COPY		www.fciconnect.com	
rev.	ecn	no.	dr	date	linear	.0 ± 0.25	projection	title SNAP-IN MODULAR JACK ASS'Y	
L						.00 ± 0.13			
					angles	.000± 0.05		product family	
					dr	KCHOU 04/26/92	unit	code	
					enr	TONY CHIEN 04/26/92	mm/inch	TWN	
					chr	TONY CHIEN 04/26/92	scale	sheet	
					appd	JENN TSAO 04/26/92	2/1	2 OF 2	
sheet	revision								
index	sheet								